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| <b>INFORMATION<br/>DISCLOSURE<br/>STATEMENT</b><br> | Atty. Docket No.: 54682US002                                     | Serial No.: 09/507,108 |
|  | Applicant(s): Mary M. SWENSON                                    | Confirmation No.: 7637 |
|  | Application Filing Date: 17 February 2000                        | Group: 3761            |
|  | Information Disclosure Statement mailed: <u>January 20, 2004</u> |                        |

## U.S. PATENT DOCUMENTS

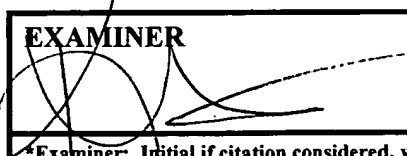
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| L                | 6,326,410 B1    | 12/04/01 | Cheong | 521   | 67       |                            |
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| L                | DE 2319706 A    | 11/15/73 | Germany (English Language Abstract Included) |       |          |             | X  |
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| L                | Lopez, "Enhanced Hydrophilic Polyurethane Prepolymers for Consumer and Industrial Applications," Product Information Brochure from the Dow Chemical Company, Saginaw, Michigan, 8 pgs. (August 2001). |
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| <b>EXAMINER</b><br>  | <b>Date Considered</b><br><u>4/4/04</u> |
| <small>*Examiner: Initial if citation considered, whether or not citation is in conformance with MPEP 609; Draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.</small> |   |

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**FOREIGN PATENT DOCUMENTS**

| Document Number | Date | Country | Class | SubClass | Translation |
|-----------------|------|---------|-------|----------|-------------|
|                 |      |         |       |          | Yes No      |
| NONE            |      |         |       |          |             |
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**OTHER DOCUMENTS (Including Authors, Title, Date, Pertinent Papers, etc.)**

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|  |  | NONE |
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EXAMINER

Date Considered

4/2/09

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